


## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

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|--|---|--|--|
| <b>Title of Invention</b>  | [CHIP PACKAGE STRUCTURE AND PROCESS FOR FABRICATING THE SAME] |  |  |
| Application Type : regular, utility<br>Attorney Docket Number : 11843-US-PA  |   |  |  |
| Correspondence address:<br>Customer Number: 31561<br>   |   |  |  |
| Priority Data:<br><br>Doc.No: 2003-117601; Country -JP ; Date: 2003-04-22 us-priority-claimed<br>Doc.No: 92129524; Country -TW ; Date: 2003-10-24 us-priority-claimed  |   |  |  |
| <b>Inventors Information:</b><br><br><u>Inventor 1:</u><br><b>Applicant Authority Type:</b> Inventor<br><b>Citizenship:</b> TW<br><b>Name prefix:</b> Mr.<br><b>Given Name:</b> Kai-Chi<br><b>Family Name:</b> Chen<br><b>Residence:</b><br><b>City of Residence:</b> Nantou County<br><b>Country of Residence:</b> TW<br><b>Address-1 of Mailing Address:</b> No. 269, Jhongjheng Rd., Caotun Township,<br><b>Address-2 of Mailing Address:</b><br><b>City of Mailing Address:</b> Nantou County<br><b>State of Mailing Address:</b><br><b>Postal Code of Mailing Address:</b> 542<br><b>Country of Mailing Address:</b> TW<br><b>Phone:</b><br><b>Fax:</b><br><b>E-mail:</b><br><br><u>Inventor 2:</u> |   |  |  |

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Inventor 3:

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**Applicant Authority Type:** Inventor  
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.